

$R_{\thetaJC}$	Thermal Resistance, Junction to Case		0.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	45	C/W

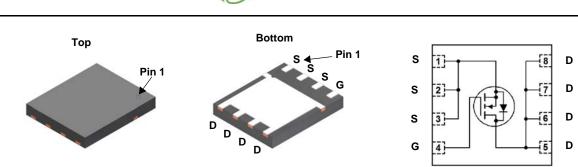
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86202	FDMS86202	Power 56	13 "	12 mm	3000 units

July 2014

FAIRCHILD **FDMS86202** 

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench  $^{\textcircled{B}}$  process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior



Symbol	Paramete		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			120	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		64	
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	13.5	Α
	-Pulsed		(Note 4)	240	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	600	mJ
D	Power Dissipation	T <sub>C</sub> = 25 °C		156	w
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.7	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperatu	ire Range		-55 to +150	°C
Thermal Ch	naracteristics				

## **Package Marking and Ordering Information**

1

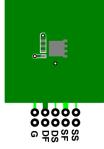
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	120			V
ΔΒV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		103		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 96 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.1	4.0	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		-10		mV/°0
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13.5 A		6.0	7.2	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 11.5 A		8.1	10.3	mΩ
		$V_{GS}$ = 10 V, I <sub>D</sub> = 13.5 A,T <sub>J</sub> = 125 °C		10.9	13.2	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 13.5 A		44		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			3195	4250	pF
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, — f = 1 MHz		449	600	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			17	30	pF
R <sub>g</sub>	Gate Resistance		0.1	0.9	2.7	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			21	33	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 60 V, I <sub>D</sub> = 13.5 A,		6	13	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		27	44	ns
t <sub>f</sub>	Fall Time			5	11	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		45	64	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 60 V,$		29	41	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 13.5 A		14.3		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			8.7	1	nC

### **Drain-Source Diode Characteristics**

V	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.1 A (Note 2	) 0.69	1.2	V
V <sub>SD</sub>	Source to Drain Diode Torward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 13.5 A (Note 2	) 0.76	1.3	v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 13.5 A, di/dt = 100 A/μs	73	118	ns
Q <sub>rr</sub>	Reverse Recovery Charge	IF = 13.5 A, αι/αι = 100 A/μs		187	nC

Notes:

1. R<sub>0,JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

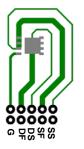


2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

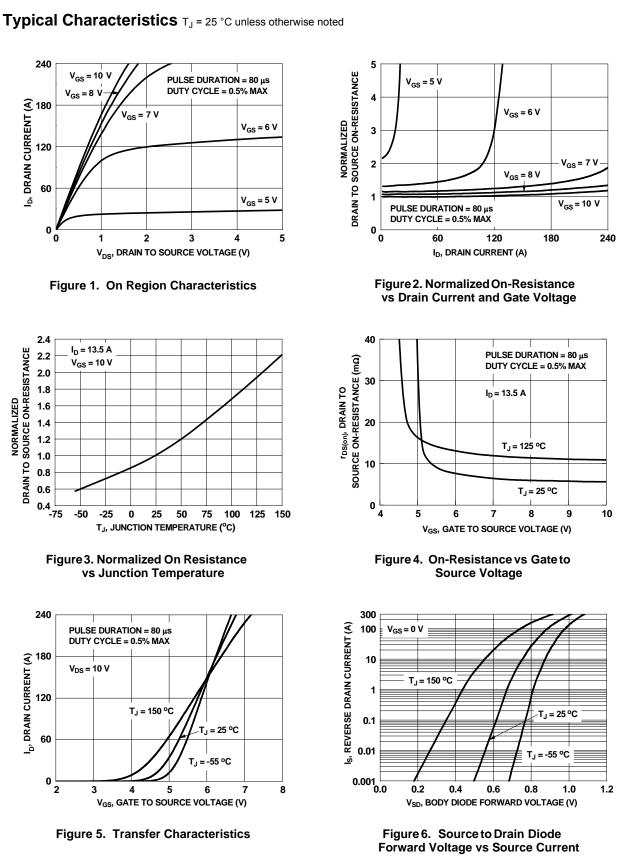
a) 45 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

3. E<sub>AS</sub> of 600 mJ is based on starting T<sub>J</sub> = 25 °C, L = 3 mH, I<sub>AS</sub> = 20 A, V<sub>DD</sub> = 120 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 65 A.

4. Pulse Id limited by junction temperature, td ≤ 100  $\mu$ s, please refer to SOA curve for more details.

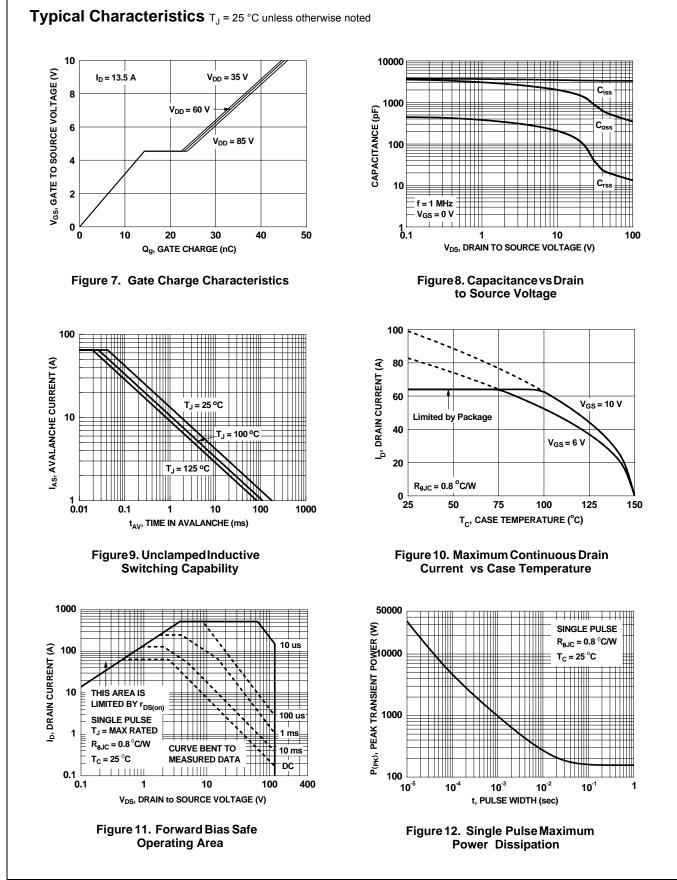


b) 115 °C/W when mounted on a minimum pad of 2 oz copper.

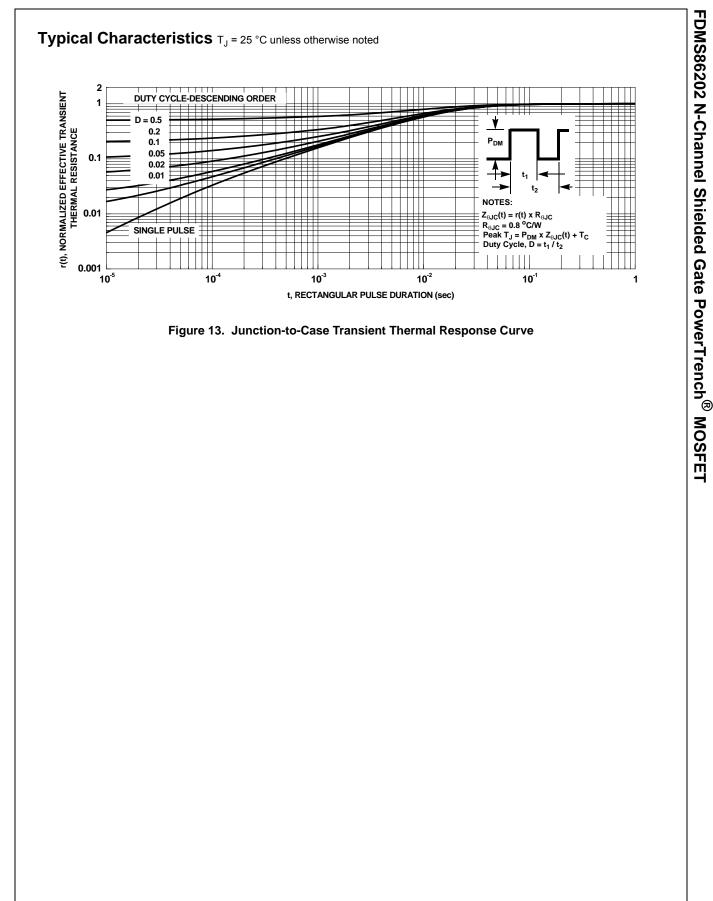


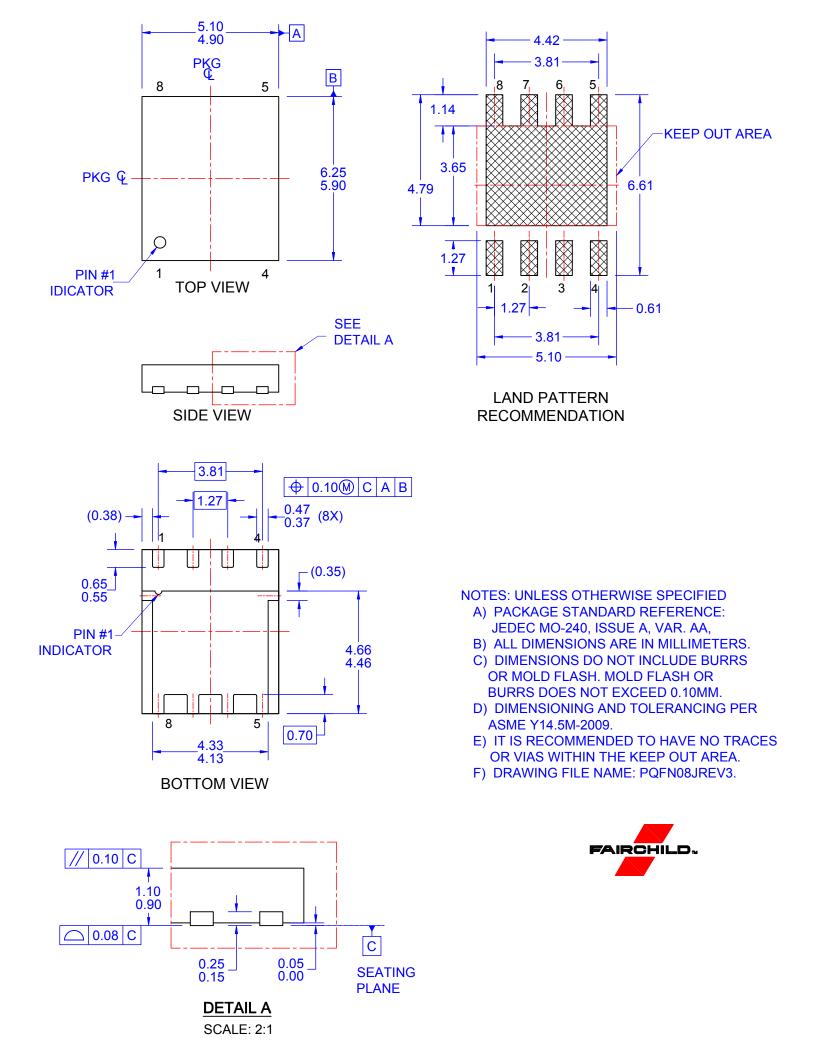
NORMALIZED

FDMS86202 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET



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